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# PM4575J

Silicon N-Channel Power MOS FET Module

# HITACHI

November 1996

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## Application

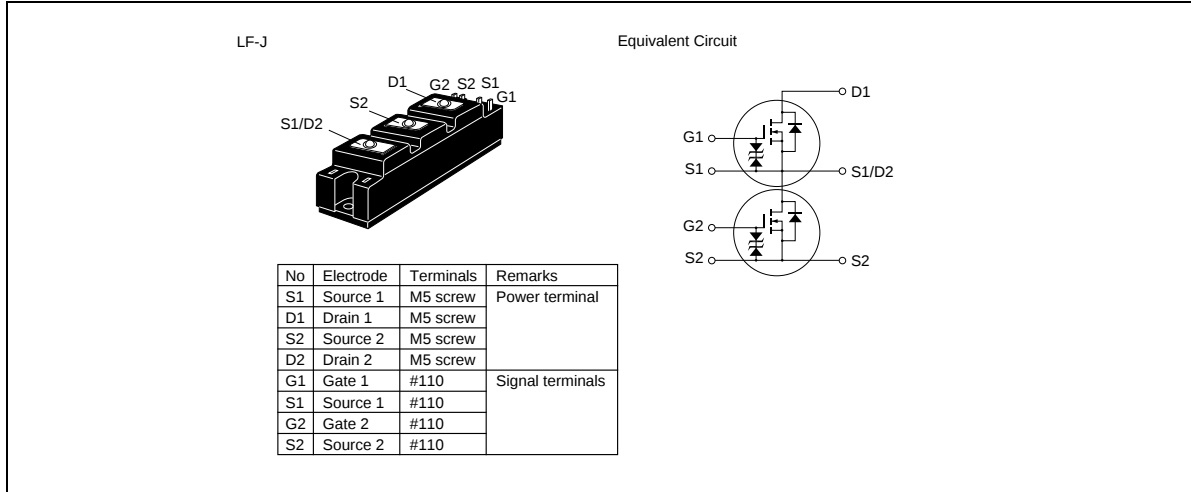
High Speed Power Switching

## Features

- Equipped with Power MOS FET
- Low on-resistance
- High speed switching
- Low drive current
- Wide area of safe operation
- Inherent parallel diode between source and drain
- Isolated base from Terminal
- Suitable for motor driver, switching regulator and etc.

# PM4575J

## Outline



## Absolute Maximum Ratings (Ta = 25°C) (Per FET chip)

| Item                                      | Symbol         | Rating      | Unit |
|-------------------------------------------|----------------|-------------|------|
| Drain source voltage                      | $V_{(BR)DSS}$  | 450         | V    |
| Gate source voltage                       | $V_{(BR)GSS}$  | ±30         | V    |
| Drain current                             | $I_D$          | 75          | A    |
| Drain peak current                        | $I_{D(peak)}$  | 180         | A    |
| Body to drain diode reverse drain current | $I_{DR}$       | 75          | A    |
| Body to drain diode reverse peak current  | $I_{DR(peak)}$ | 180         | A    |
| Channel dissipation                       | $P_{ch}^{*1}$  | 300         | W    |
| Channel temperature                       | $T_{ch}$       | 150         | °C   |
| Storage temperature                       | $T_{stg}$      | −45 to +125 | °C   |
| Insulation dielectric                     | $V_{iso}^{*2}$ | 2000        | Vrms |

Notes 1. Value at Ta = 25°C  
2. Base to terminals AC minute

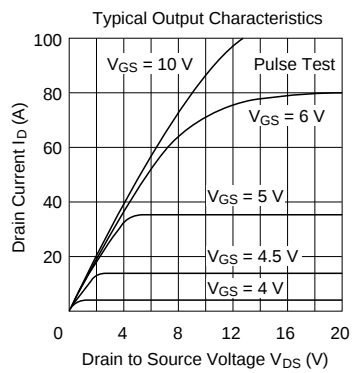
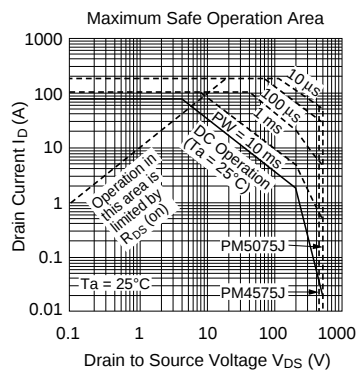
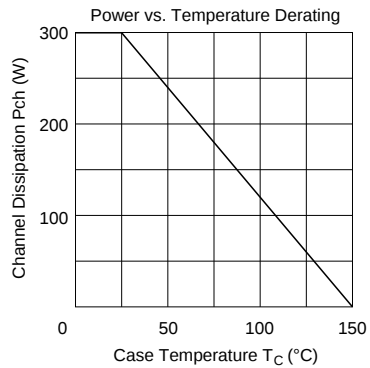
**Electrical Characteristics** (Ta = 25°C) (Per FET chip)

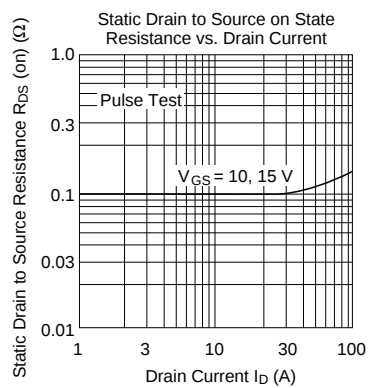
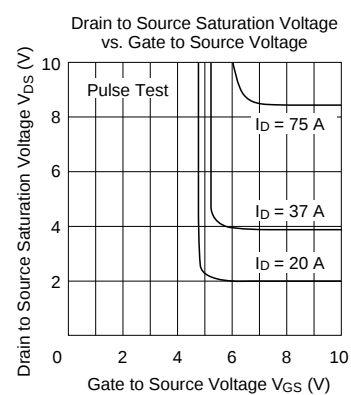
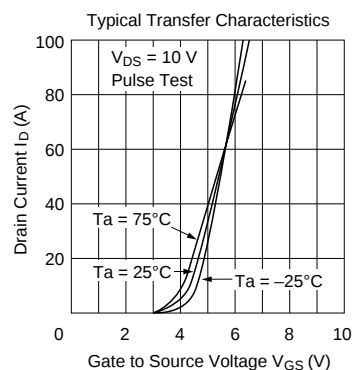
| Item                                       | Symbol        | Min | Typ  | Max  | Unit | Test conditions                                                                               |
|--------------------------------------------|---------------|-----|------|------|------|-----------------------------------------------------------------------------------------------|
| Drain to source breakdown voltage          | $V_{(BR)DSS}$ | 450 | —    | —    | V    | $I_D = 10 \text{ mA}$ , $V_{GS} = 0 \text{ V}$                                                |
| Gate to source leak current                | $I_{GSS}$     | —   | —    | ±10  | μA   | $V_{GS} = \pm 25 \text{ V}$ , $V_{DS} = 0 \text{ V}$                                          |
| Gate to source breakdown voltage           | $V_{(BR)GSS}$ | ±30 | —    | —    | V    | $I_G = \pm 100 \text{ μA}$ , $V_{DS} = 0 \text{ V}$                                           |
| Drain leak current                         | $I_{DSS}$     | —   | —    | 500  | μA   | $V_{DS} = 360 \text{ V}$ , $V_{GS} = 0 \text{ V}$                                             |
| Gate to source threshold voltage           | $V_{GS(th)}$  | 2.0 | —    | 3.0  | V    | $I_D = 1 \text{ mA}$ , $V_{DS} = 10 \text{ V}$                                                |
| Drain to source saturation voltage         | $V_{DS(on)}$  | —   | 3.7  | 4.44 | V    | $I_D = 37 \text{ A}$ , $V_{GS} = 10 \text{ V}^{*1}$                                           |
| Static drain to source on state resistance | $R_{DS(on)}$  | —   | 0.10 | 0.12 | Ω    | $I_D = 37 \text{ A}$ , $V_{GS} = 10 \text{ V}^{*1}$                                           |
| Forward transfer admittance                | $ y_{fs} $    | —   | 45   | —    | S    | $I_D = 37 \text{ A}$ , $V_{DS} = 10 \text{ V}^{*1}$                                           |
| Input capacitance                          | $C_{iss}$     | —   | 9600 | —    | pF   | $V_{DS} = 10 \text{ V}$ , $V_{GS} = 0 \text{ V}$<br>$f = 1 \text{ MHz}$                       |
| Output capacitance                         | $C_{oss}$     | —   | 2300 | —    |      |                                                                                               |
| Reverse transfer capacitance               | $C_{rss}$     | —   | 330  | —    |      |                                                                                               |
| Turn-on delay time                         | $t_{d(on)}$   | —   | 100  | —    | ns   | $I_D = 37 \text{ A}$ , $V_{GS} = 10 \text{ V}$<br>$R_g = 50 \text{ Ω}$<br>$R_L = 1 \text{ Ω}$ |
| Rise time                                  | $t_r$         | —   | 310  | —    |      |                                                                                               |
| Turn-off delay time                        | $t_{d(off)}$  | —   | 550  | —    |      |                                                                                               |
| Fall time                                  | $t_f$         | —   | 135  | —    |      |                                                                                               |
| Body to drain diode forward voltage        | $V_{DF}$      | —   | 1.8  | —    | V    | $I_F = 75 \text{ A}$ , $V_{GS} = 0 \text{ V}$                                                 |
| Body to drain diode reverse recovery time  | $t_{rr}$      | —   | 130  | —    | ns   | $I_F = 75 \text{ A}$ , $V_{GS} = 0 \text{ V}$<br>$di/dt = 100 \text{ A/ms}$                   |

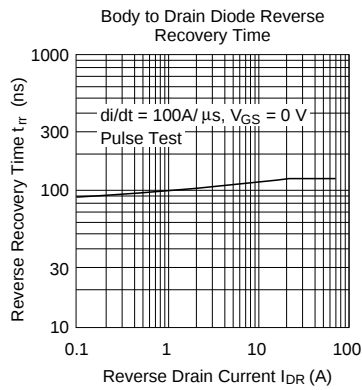
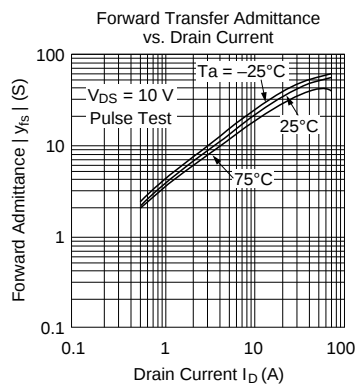
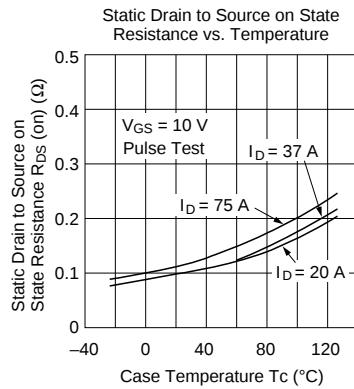
Note 1. Pulse Test

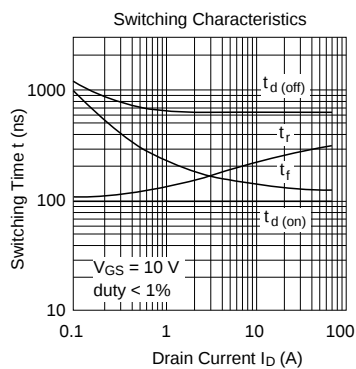
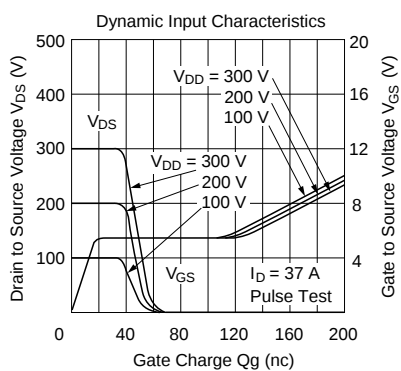
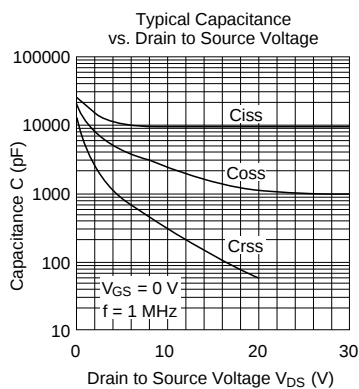
**Mechanical Characteristics**

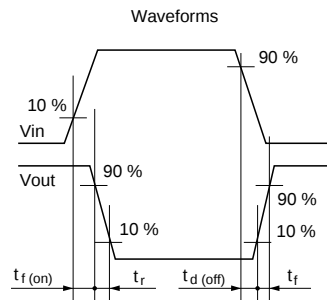
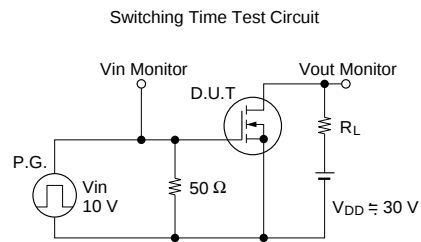
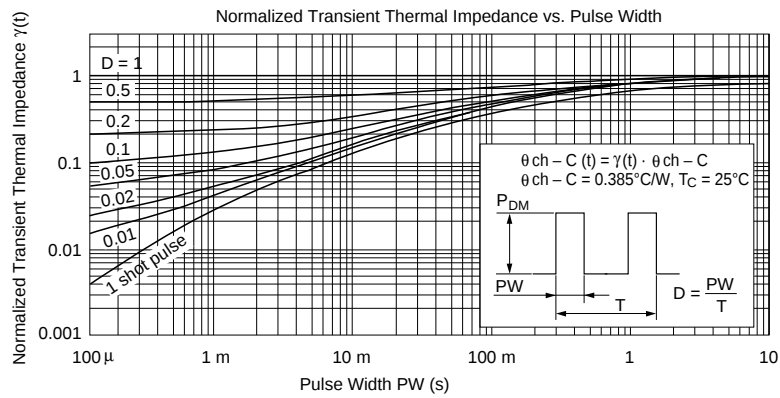
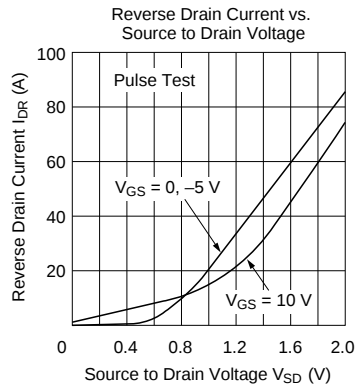
| Item            | Symbol | Condition                                 | Rating       | Unit |
|-----------------|--------|-------------------------------------------|--------------|------|
| Fixing strength | —      | Mounting into main-terminal with M4 screw | 1.45 to 1.95 | N-m  |
|                 | —      | Mounting into heat sink with M5 screw     | 1.95 to 2.9  | N-m  |
| Weight          | —      | Typical value                             | 200          | g    |













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